

Development of High Performance p-type Semiconductors for Transistors



• Time: 2025.12.02. (Tue) 16:00-17:15 • Place: 104-E206 Classroom

Speaker

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Abstract

Developing high-mobility p-type semiconductors that can be grown using silicon-compatible processes at low temperatures, has remained challenging in the electronics community to integrate complementary electronics with the well-developed n-type counterparts.

This presentation will discuss our recent progress in developing high-performance p-type semiconductors as channel materials for thin film transistors. For the first part of my talk, I present an amorphous p-type oxide semiconductor composed of selenium-alloyed tellurium in a tellurium sub-oxide matrix, demonstrating its utility in high-performance, stable p-channel TFTs, and complementary circuits [1]. Theoretical analysis unveils a delocalized valence band from tellurium 5p bands with shallow acceptor states, enabling excess hole doping and transport. Selenium alloying suppresses hole concentrations and facilitates the p orbital connectivity, realizing high-performance p-channel TFTs with an average field-effect hole mobility of ~15 cm² V⁻¹ s⁻¹ and on/off current ratios of $10^6 \sim 10^7$, along with wafer-scale uniformity and long-term stabilities under bias stress and ambient aging.

Next, I will present high-performance tin (Sn^{2+}) halide perovskite based p-type transistors using cesium-tin-triiodide-based semiconducting layers [2, 3]. The optimized devices exhibit high field-effect hole mobilities of over $50 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$, large current modulation greater than 10^8 , and high operational stability and reproducibility [4]. In addition, we explore triple A-cations of caesium-formamidinium-phenethylammonium to create high-quality cascaded Sn perovskite channel films. As such, the optimized TFTs show record hole mobilities of over $70 \text{ cm}^2 \text{ V}^{-1} \text{ s}^{-1}$ and on/off current ratios of over 10^8 , comparable to the commercial low-temperature polysilicon technique level. In the final part, I would like to briefly introduce our recent halide perovskite transistors, fabricated by thermal evaporation [5].

References

- [1] A. Liu, Y.-Y. Noh et al, Nature, 629, 798-802 (2024)
- [2] A. Liu, Y.-Y. Noh et al, Nature Electronics **5**, 78-83 (2022)
- [3] H. Zhu, Y.-Y. Noh et al, Nature Electronics 6, 650-657 (2023)
- [4] A. Liu, Y.-Y. Noh et al, Nature Electronics 6, 559-571 (2023)
- [5] Y, Reo, Y.-Y. Noh et al, Nature Electronics, **8**, 403-410 (2025).

